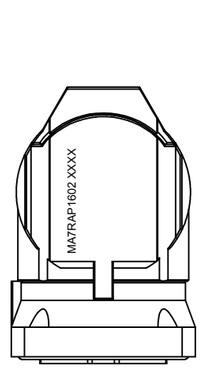
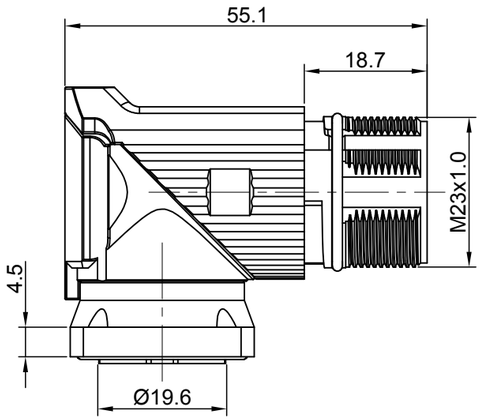
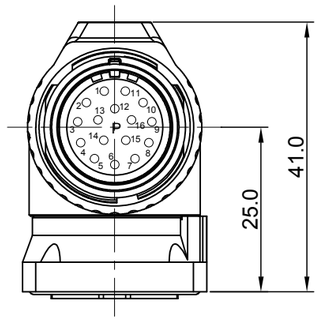
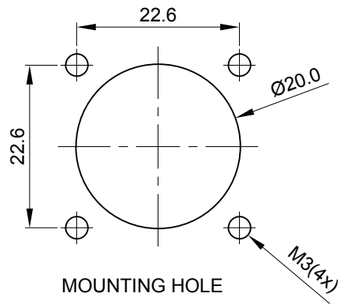
REVISIONS					
REV	ECO	DESCRIPTION	DATE	BY	APPR
A1	-	FIRST RELEASE	Jan.12.2018	White	Tommy



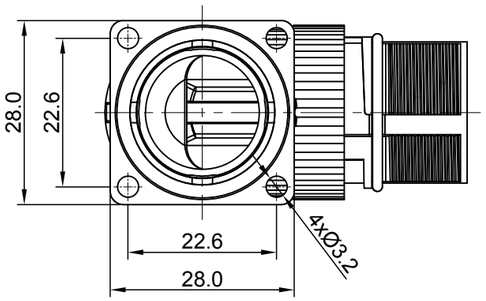


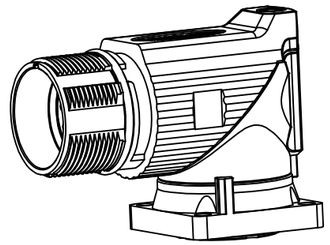
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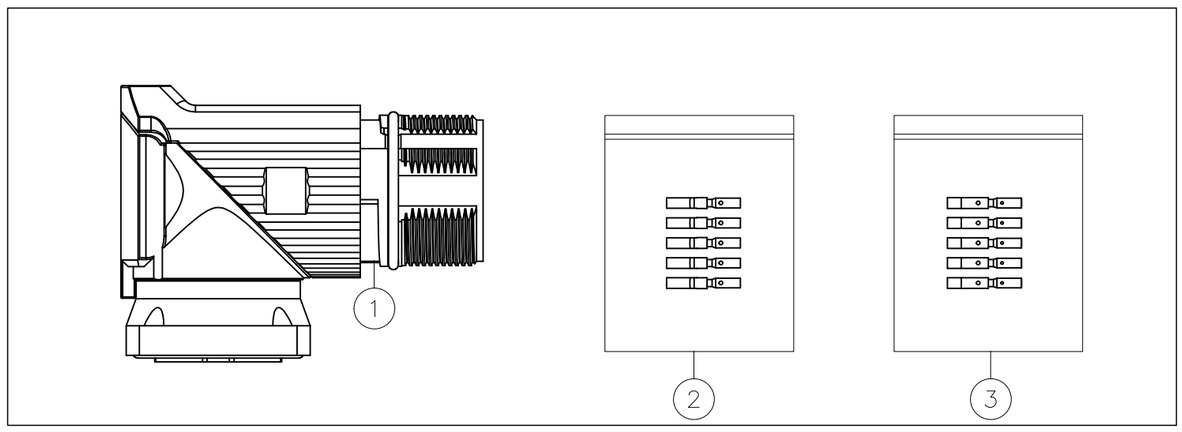




MOUNTING HOLE







NOTES: UNLESS OTHERWISE SPECIFIED

1. MATERIAL:
   INSULATION INSERT: PA66,UL94 V0
   SEAL: VITON
   HOUSING BODY: ZINC DIE CAST, NICKEL PLATED
   CONTACT: COPPER ALLOY, GOLD PLATED

2. SPECIFICATIONS:
   2.1 CURRENT RATING: 9 AMPS
   2.2 VOLTAGE RATING: 125 V AC/DC
   2.3 OPERATING TEMPERATURE: -20°C TO +130°C
   2.4 DIELECTRIC WITHSTANDING VOLTAGE: LESS THAN 2 MILLIAMPS CURRENT LEAKAGE @ 2500 VOLTS AC.
   2.5 DEGREE OF PROTECTION: IP67 (MATED CONDITION)
   2.6 DEGREE OF POLLUTION: 3 PER UL840
   2.7 OVERVOLTAGE CATEGORY: III PER UL840
   2.8 MATING CYCLE DURABILITY: >500 CYCLES
   2.9 RoHS COMPLIANT

3. ALL DIMENSIONS ARE FOR REFERENCE USE ONLY.

QUANTITY	PART NUMBER	DESCRIPTION	ITEM
16	SC000030	CONTACT, SOCKET, Ø1.0mm,CRIMP 24~28AWG	3
16	SC000044	CONTACT, SOCKET, Ø1.0mm,CRIMP 18~22AWG	2
1	MA7RAP1602	CONNECTOR	1

MATERIALS LIST

UNLESS OTHERWISE SPECIFIED
1) All dimensions are in metric(mm).
2) Tolerances are as follows:
1 PL DEC ±0.30 | Fractions ±1/64
2 PL DEC ±0.15 | Angles ±1°
3 PL DEC ±0.08
3) Note reference = (x)

MATERIAL SPECIFICATIONS:

PROCESS SPECIFICATIONS:

NEXT ASS'Y:

SIGNATURES		DATE
DRAWN:	White	Jan.12.2018
CHECKED:	Tod	Jan.12.2018
ENGINEER:		
APPROVAL:	Tommy	Jan.12.2018
CUSTOMER:		

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Amphenol
Sine Systems - www.amphenol-sine.com
44724 Morley Drive
Clinton Township, MI 48036

KIT,M23A,REC.,RA,16P,P TYPE

SIZE	TYPE	DWG NO:	REVISION
B	C-	MA7RAP1602S-KIT	A1

SCALE: NONE SHEET 1 OF 1

TITLE: KIT,M23A,REC.,RA,16P,P TYPE
DWG NO: MA7RAP1602S-KIT
REV: A1
SH: 1
OF: 1

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